ON Semiconductor

Is Now



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www.onsemi.com

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MOSFET – Power, N-Channel, SUPERFET® III, Automotive, Easy Drive
650 V, 30 A, 99 mΩ

NVB099N65S3

Description

SUPERFET III MOSFET is ON Semiconductor's brand−new high voltage super−junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on−resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provides superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

Features

- AEC−Q101 Qualified
- 700 V @ T_J = 150°C
- Typ. $R_{DS(on)}$ = 79 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 61 nC)
- Low Effective Output Capacitance (Typ. $C_{oss(eff.)}$ = 544 pF)
- 100% Avalanche Tested
- These Devices are Pb−Free and are RoHS Compliant

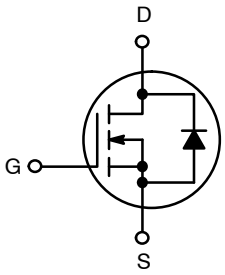
Applications

- Automotive On Board Charger
- Automotive DC/DC Converter for HEV

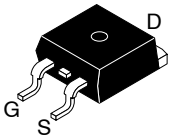
ON Semiconductor®

www.onsemi.com

V_{DSS}	$R_{DS(ON)}$ MAX	I_D MAX
650 V	99 mΩ @ 10 V	30 A

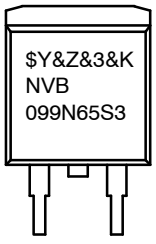


POWER MOSFET



D²−PAK
CASE 418AJ

MARKING DIAGRAM



$Y	= ON Semiconductor Logo
&Z	= Assembly Plant Code
&3	= Data Code (Year & Week)
&K	= Lot
NVB099N65S3	= Specific Device Code

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 2 of this data sheet.

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ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Symbol	Parameter		Value	Unit
V_{DSS}	Drain to Source Voltage		650	V
V_{GSS}	Gate to Source Voltage	– DC	±30	V
		– AC (f > 1 Hz)	±30	
I_D	Drain Current	– Continuous (T_C = 25°C)	30	A
		– Continuous (T_C = 100°C)	19	
I_{DM}	Drain Current	– Pulsed (Note 1)	75	A
E_{AS}	Single Pulsed Avalanche Energy (Note 2)		145	mJ
I_{AS}	Avalanche Current (Note 2)		4.4	A
E_{AR}	Repetitive Avalanche Energy (Note 1)		2.27	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
P_D	Power Dissipation	(T_C = 25°C)	227	W
		– Derate Above 25°C	1.82	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		–55 to +150	°C
T_L	Maximum Lead Temperature for Soldering, 1/8″ from Case for 5 seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse−width limited by maximum junction temperature.
2. I_{AS} = 4.4 A, R_G = 25 Ω, starting T_J = 25°C.
3. $I_{SD} \le$ 15 A, di/dt ≤ 200 A/μs, $V_{DD} \le$ 400 V, starting T_J = 25°C.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.55	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Reel Size	Tape Width	Shipping†
NVB099N65S3	NVB099N65S3	D^2–PAK	330 mm	24 mm	800 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
BV_{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650			V
		V_{GS} = 0 V, I_D = 1 mA, T_J = 150°C	700			V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient	I_D = 1 mA, Referenced to 25°C		0.68		V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 650 V, V_{GS} = 0 V			1	μA
		V_{DS} = 520 V, T_C = 125°C		1.4		
I_{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V			±100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 0.74 mA	2.5		4.5	V
$R_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10 V, I_D = 15 A		79	99	mΩ
g_{FS}	Forward Transconductance	V_{DS} = 20 V, I_D = 15 A		19		S
DYNAMIC CHARACTERISTICS						
C_{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz		2480		pF
C_{oss}	Output Capacitance			55		pF
$C_{oss(eff.)}$	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		544		pF
$C_{oss(er.)}$	Energy Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		78		pF
$Q_{g(tot)}$	Total Gate Charge at 10 V	V_{DS} = 400 V, I_D = 15 A, V_{GS} = 10 V (Note 4)		61		nC
Q_{gs}	Gate to Source Gate Charge			15		nC
Q_{gd}	Gate to Drain “Miller” Charge			25		nC
ESR	Equivalent Series Resistance	f = 1 MHz		0.4		Ω
SWITCHING CHARACTERISTICS						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 400 V, I_D = 15 A, V_{GS} = 10 V, R_g = 4.7 Ω (Note 4)		23		ns
t_r	Turn-On Rise Time			24		ns
$t_{d(off)}$	Turn-Off Delay Time			60		ns
t_f	Turn-Off Fall Time			5		ns
SOURCE-DRAIN DIODE CHARACTERISTICS						
I_S	Maximum Continuous Source to Drain Diode Forward Current				30	A
I_{SM}	Maximum Pulsed Source to Drain Diode Forward Current				75	A
V_{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0 V, I_{SD} = 15 A			1.2	V
t_{rr}	Reverse Recovery Time	V_{DD} = 400 V, I_{SD} = 15 A, dI_F/dt = 100 A/μs		408		ns
Q_{rr}	Reverse Recovery Charge			8.4		μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

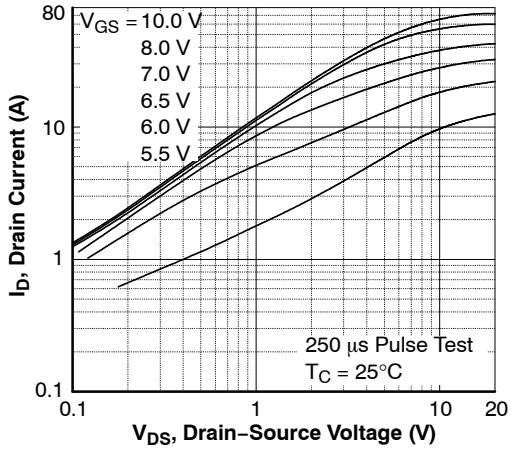

Figure 1. On−Region Characteristics (25°C)

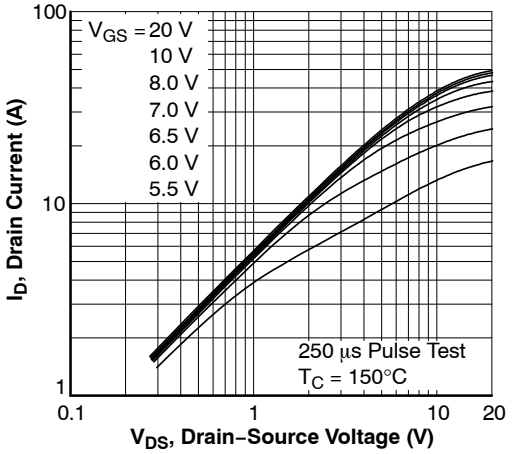

Figure 2. On−Region Characteristics (150°C)

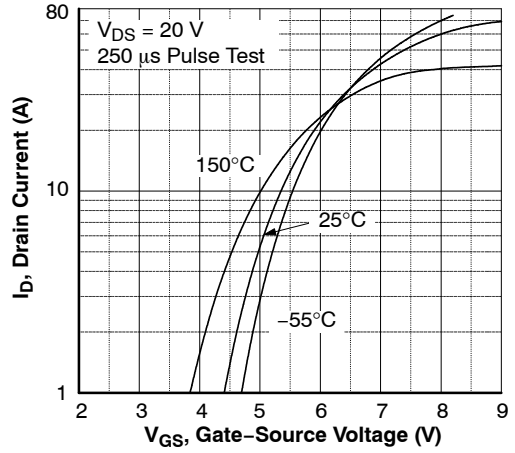

Figure 3. Transfer Characteristics

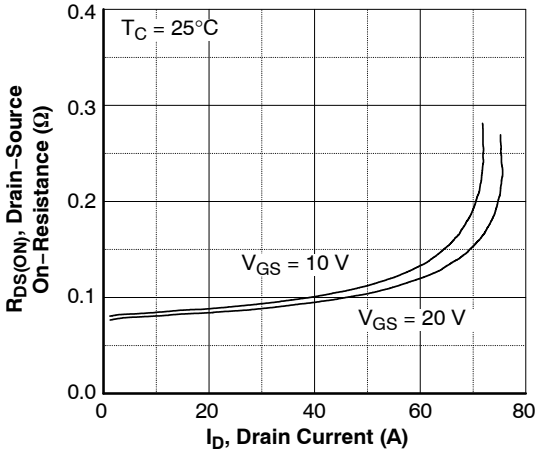

Figure 4. On−Resistance Variation vs. Drain Current and Gate Voltage

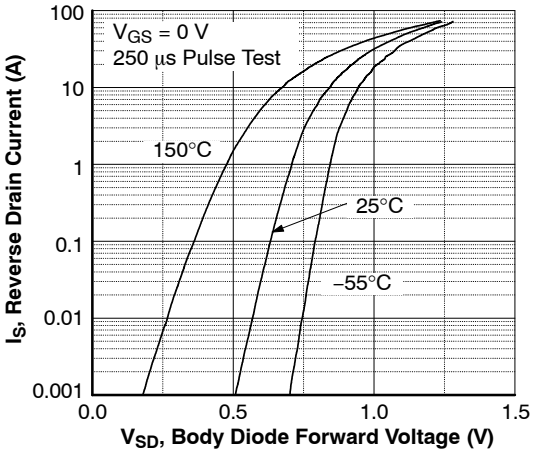

Figure 5. Body Diode Forward Voltage Variation vs. Source Current and Temperature

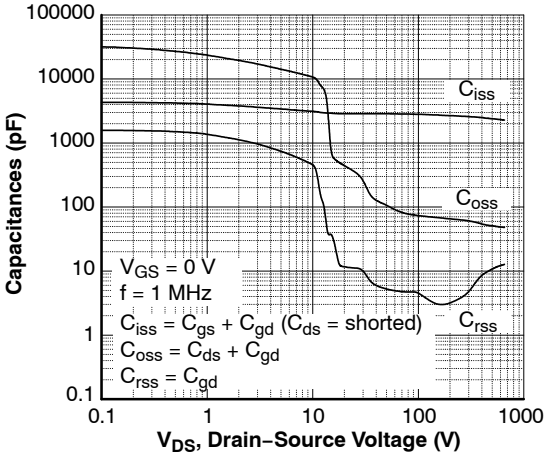

Figure 6. Capacitance Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

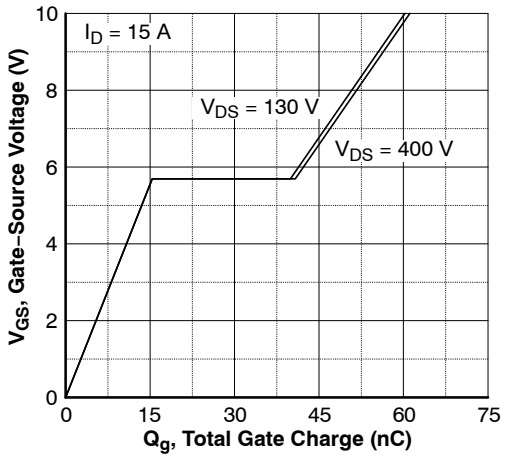

Figure 7. Gate Charge Characteristics

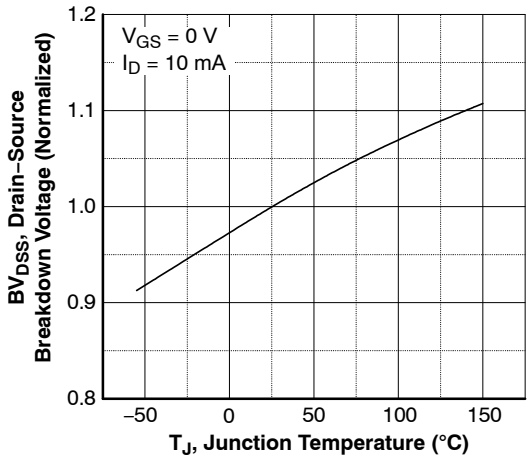

Figure 8. Breakdown Voltage Variation vs. Temperature

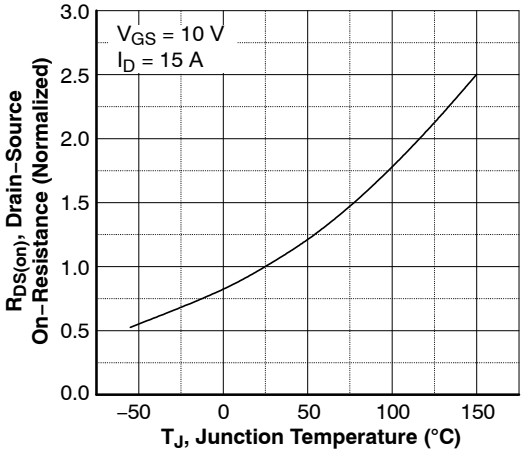

Figure 9. On−Resistance Variation vs. Temperature

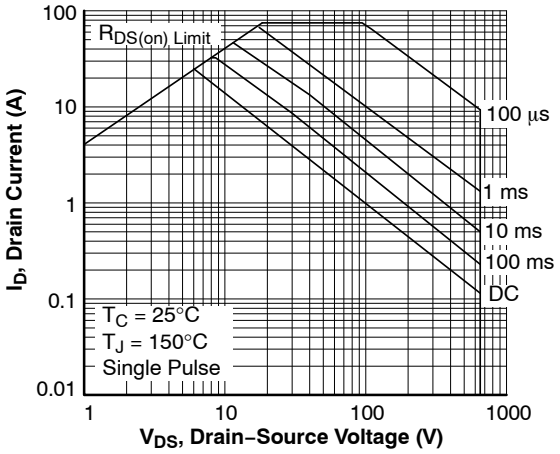

Figure 10. Maximum Safe Operating Area

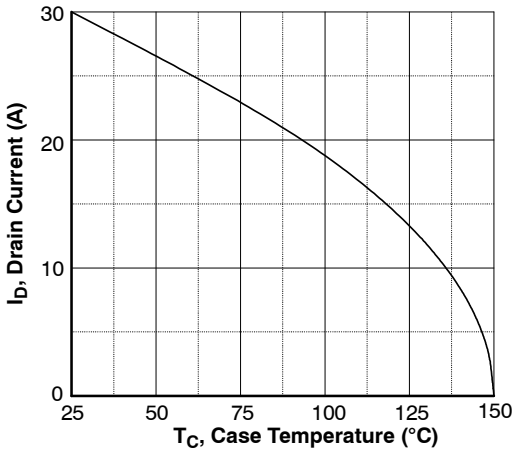

Figure 11. Maximum Drain Current vs. Case Temperature

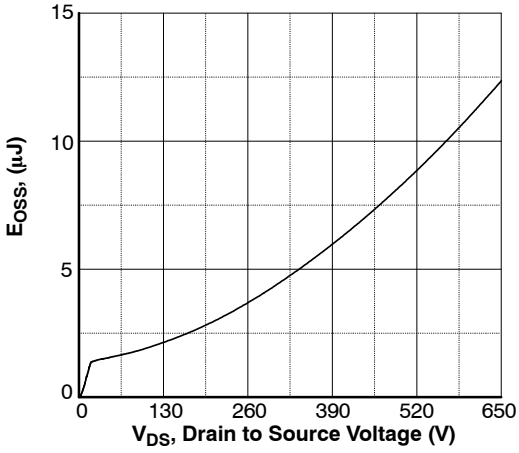

Figure 12. E_{OSS} vs. Drain to Source Voltage

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

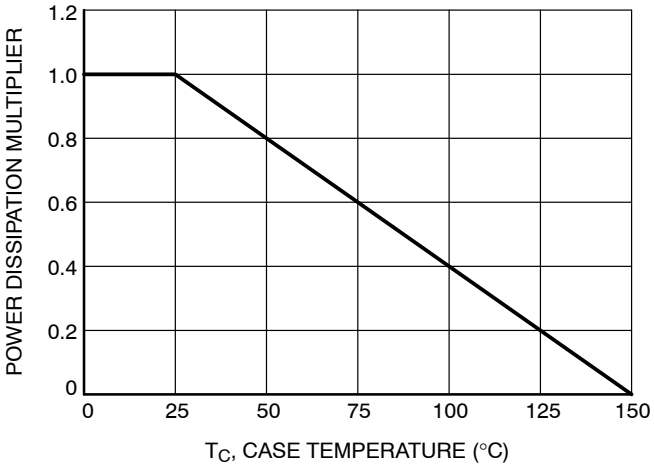

Figure 13. Normalized Power Dissipation vs. Case Temperature

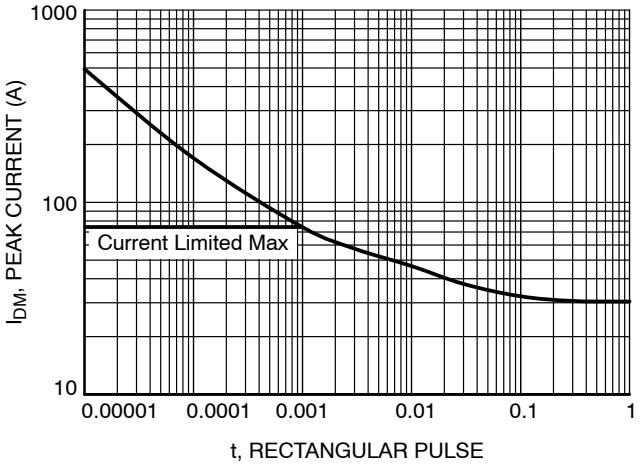

Figure 14. Peak Current Capability

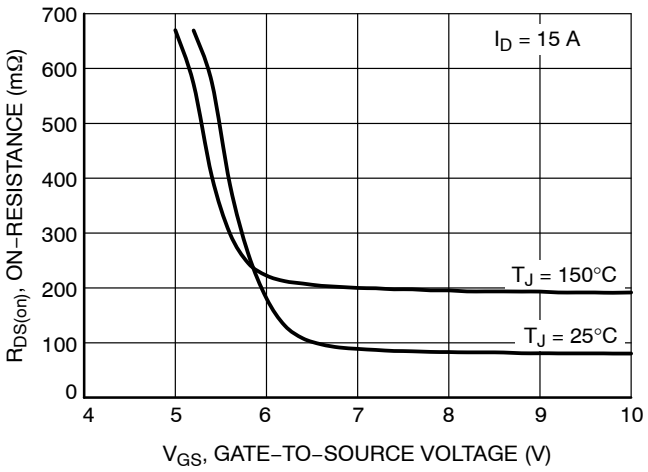

Figure 15. $R_{DS(on)}$ vs. Gate Voltage

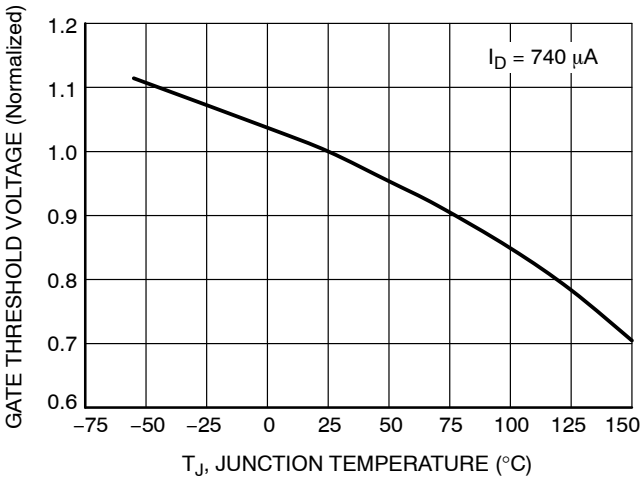

Figure 16. Normalized Gate Threshold Voltage vs. Temperature

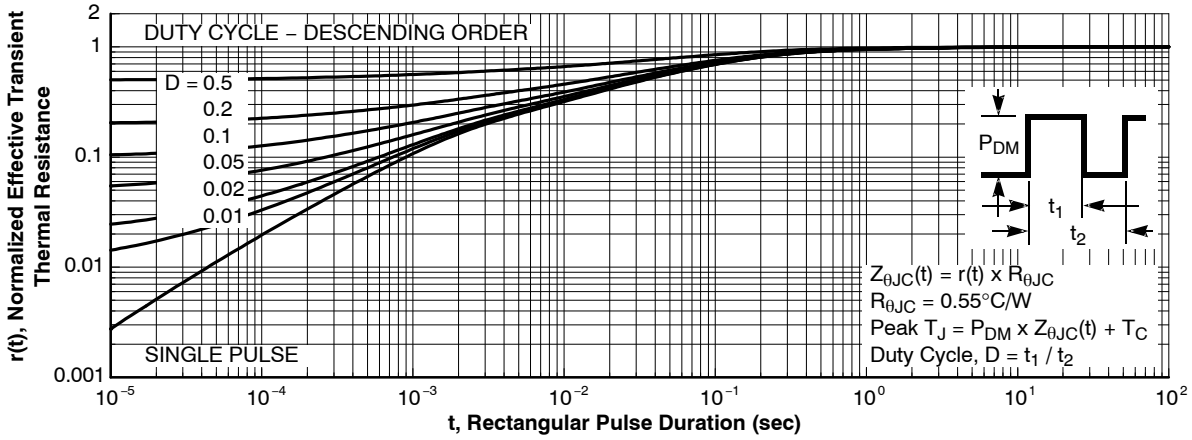

Figure 17. Transient Thermal Response Curve

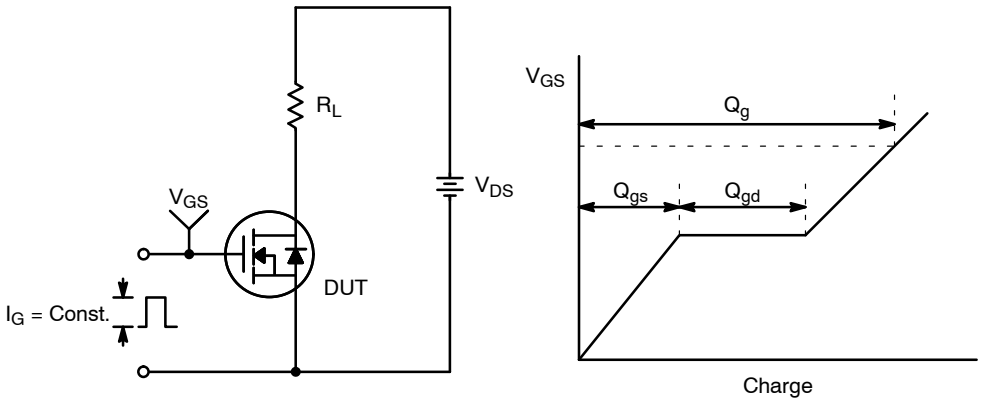

Figure 18. Gate Charge Test Circuit & Waveform

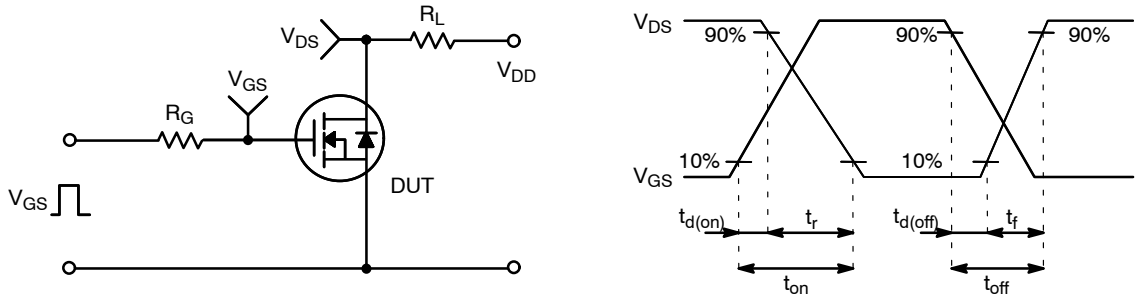

Figure 19. Resistive Switching Test Circuit & Waveforms

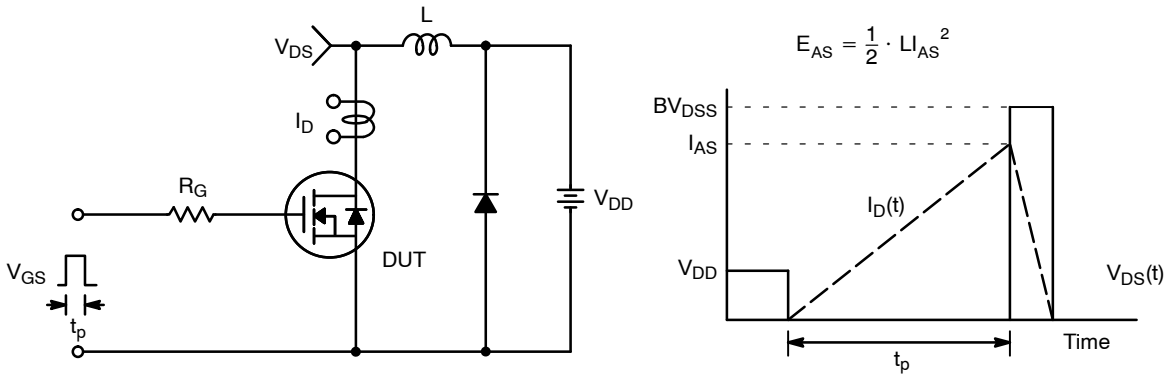

Figure 20. Unclamped Inductive Switching Test Circuit & Waveforms

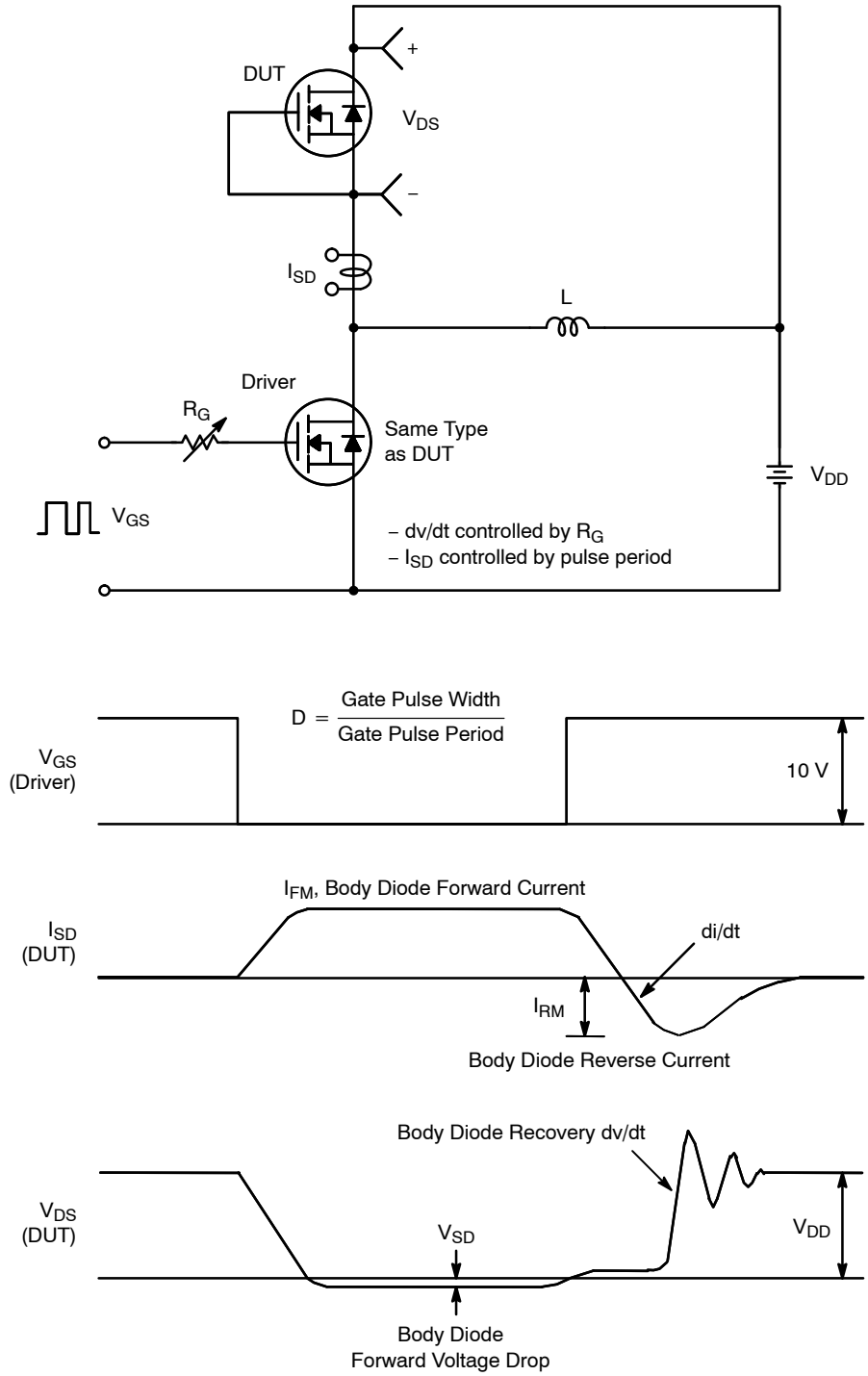

Figure 21. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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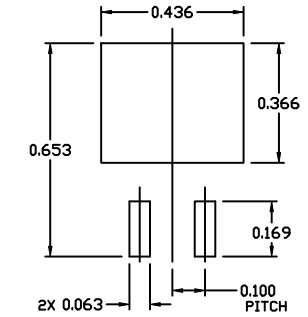
NVB099N65S3

PACKAGE DIMENSIONS

D²PAK−3 (TO−263, 3−LEAD)
CASE 418AJ
ISSUE E



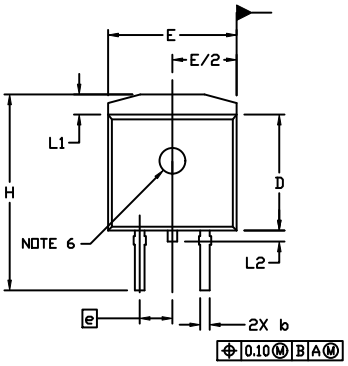
RECOMMENDED
MOUNTING FOOTPRINT

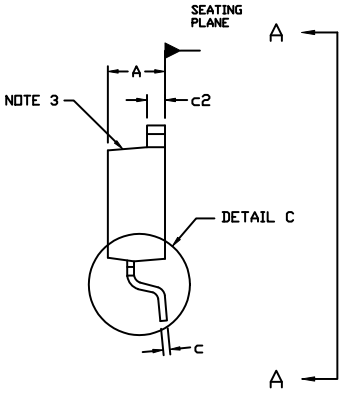
* For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

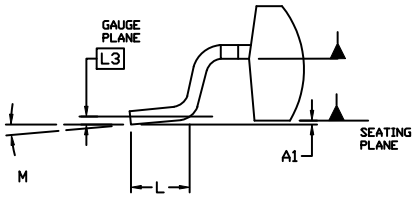
NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: INCHES
3. CHAMFER OPTIONAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.005 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
5. THERMAL PAD CONTOUR IS OPTIONAL WITHIN DIMENSIONS E, L1, D1, AND E1.
6. OPTIONAL MOLD FEATURE.
7. ①, ② … OPTIONAL CONSTRUCTION FEATURE CALL OUTS.

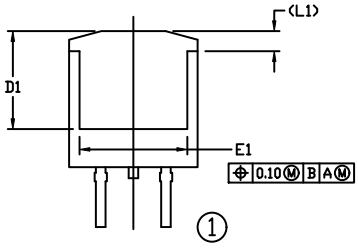
DIM	INCHES		MILLIMETERS	
	MIN.	MAX.	MIN.	MAX.
A	0.160	0.190	4.06	4.83
A1	0.000	0.010	0.00	0.25
b	0.020	0.039	0.51	0.99
c	0.012	0.029	0.30	0.74
c2	0.045	0.065	1.14	1.65
D	0.330	0.380	8.38	9.65
D1	0.260	---	6.60	---
E	0.380	0.420	9.65	10.67
E1	0.245	---	6.22	---
e	0.100 BSC		2.54 BSC	
H	0.575	0.625	14.60	15.88
L	0.070	0.110	1.78	2.79
L1	---	0.066	---	1.68
L2	---	0.070	---	1.78
L3	0.010 BSC		0.25 BSC	
M	−8°	8°	−8°	8°



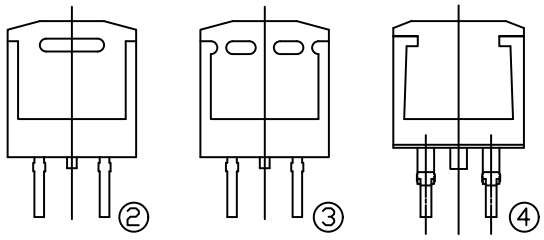




DETAIL C
TIP LEADFORM
ROTATED 90° CW



VIEW A−A



VIEW A−A
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